L Numb r	Hits	Search Text	DB	Tim stamp
1	1	(makiguichi).inv.	USPAT	2004/01/11 14:20
2	25	(makiguchi).inv.	USPAT	2004/01/11
•	3312	(219/390 or 219/405 or 219/411 or 219/392 or	USPAT	2004/01/11
		219/402 or 219/521 or 219/544 or 118/724 or		14:20
		118/725 or 118/50.1 or 118/500 or 392/416 or		
_	1337	392/418).ccls. and (substrate\$1 or wafer\$1) ((219/390 or 219/405 or 219/411 or 219/392	USPAT	2004/01/10
•	1337	or 219/402 or 219/521 or 219/544 or 118/724	USPAI	18:04
		or 118/725 or 118/50.1 or 118/500 or 392/416		10.04
		or 392/418).ccls. and (substrate\$1 or		
		wafer\$1)) and (heat\$3 near8 (support\$1 or		
		holder\$1 or susceptor\$1))		
•	213	(((219/390 or 219/405 or 219/411 or 219/392	USPAT	2004/01/10
		or 219/402 or 219/521 or 219/544 or 118/724		18:04
		or 118/725 or 118/50.1 or 118/500 or 392/416		
		or 392/418).ccls. and (substrate\$1 or		
		wafer\$1)) and (heat\$3 near8 (support\$1 or		
		holder\$1 or susceptor\$1))) and (resistive		
	975	near8 heat\$3) ((219/390 or 219/405 or 219/411 or 219/392	USPAT	2004/01/10
•	9/5	or 219/402 or 219/521 or 219/544 or 118/724	USPAI	18:25
		or 118/725 or 118/50.1 or 118/500 or 392/416		10.23
		or 392/418).ccls. and (substrate\$1 or		
		wafer\$1)) and (heat\$3 near8 plate\$1)		
-	453	(((219/390 or 219/405 or 219/411 or 219/392	USPAT	2004/01/10
		or 219/402 or 219/521 or 219/544 or 118/724		18:27
		or 118/725 or 118/50.1 or 118/500 or 392/416		
		or 392/418).ccls. and (substrate\$1 or		
		wafer\$1)) and (heat\$3 near8 plate\$1)) and		
		(((upper or top) and (lower or bottom)) near8		
	200	plate\$1)	HCDAT	0004/04/40
•	382	((((219/390 or 219/405 or 219/411 or 219/392 or 219/402 or 219/521 or 219/544 or 118/724	USPAT	2004/01/10 18:27
	1	or 118/725 or 118/50.1 or 118/500 or 392/416		10:27
		or 392/418).ccls. and (substrate\$1 or		
		wafer\$1)) and (heat\$3 near8 plate\$1)) and		
		(((upper or top) and (lower or bottom)) near8		
		plate\$1)) not ((((219/390 or 219/405 or		
		219/411 or 219/392 or 219/402 or 219/521 or		
		219/544 or 118/724 or 118/725 or 118/50.1 or		
		118/500 or 392/416 or 392/418).ccls. and		
		(substrate\$1 or wafer\$1)) and (heat\$3 near8		
		1		
		(support\$1 or water\$1)) and (neat\$3 near8 (support\$1 or holder\$1 or susceptor\$1))) and (resistive near8 heat\$3))		